ATTY. DOCKET NO.: P6742

Group Art Unit: 2814

Examiner: Nathan Ha

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Joon Ki HONG

Serial No.: 10/017,318

Filed: December 18, 2001

STACK CHIP MODULE WITH ELECTRICAL CONNECTION AND ADHESION OF CHIPS

THROUGH A BUMP FOR IMPROVED HEAT RELEASE CAPACITY

(As Amended)

TRANSMITTAL

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

For:

Transmitted herewith is an Amendment Under Rule 1.116 and Petition for Extension of Time for filing in the above-captioned patent application.

The fee has been calculated as shown below:

	Claims	Highest	Present	Small Entity	Other Than A
	Remaining	Number	Extra	•	Small Entity
	After	Previously		Rate Addit.	(or) Rate Addit.
	Amendment	Paid For		Fee	Fee
Total	02 -	20 =	0	x 09 = \$	x 18 = \$
Indep.	01 -	03=	0	x 42 = \$	x 84 = \$
First Presentation of Multiple Dependent Claims				+130 = \$	+ 260 = \$
Total Additional Fee				\$	

XXXX A check in the amount of \$110.00 is attached for: Petition for Extension of Time (1x)

XXXX If a Petition for Extension of Time is necessary and the Petition and/or the check is not enclosed, this will act as the Petition and applicant herewith petitions the Commissioner to extend the time for response and charge any fees necessary under 37 CFR 1.17 (a)(1)-(5) to Deposit Account No. 06-1358. The Commissioner is also authorized to charge payment of any other additional fees associated with this communication or credit any overpayment to Deposit Account No. 06-1358. A duplicate copy of this sheet is attached.

> Respectfully submitted, JACOBSON HOLMAN PLLC

Yoon S. Ham

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YSH:SCB

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